

DM54/74S474 (512 x 8) 4096-Bit TTL PROM

General Description

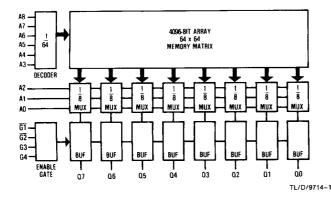
This Schottky memory is organized in the popular 512 words by 8 bits configuration. Memory enable inputs are provided to control the output states. When the device is enabled, the outputs represent the contents of the selected word. When disabled, the 8 outputs go to the "OFF" or high impedance state.

PROMs are shipped from the factory with lows in all locations. A high may be programmed into any selected location by following the programming instructions.

Features

- Advanced titanium-tungsten (Ti-W) fuses
- Schottky-clamped for high speed Address access—35 ns max Enable access—25 ns max Enable recovery—25 ns max
- PNP inputs for reduced input loading
- All DC and AC parameters guaranteed over temperature
- Low voltage TRI-SAFE™ programming
- TRI-STATE® outputs

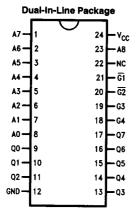
Block Diagram



Pin Names

A0-A8	Addresses
G1, G2, G3, G4	Output Enables
GND	Ground
NC	No Connection
Q0-Q7	Outputs
Vcc	Power Supply

Connection Diagrams

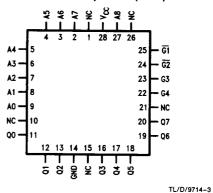


Top View

TL/D/9714-2

Order Number DM54/74S474J, 474AJ, 474BJ, DM74S474N, 474AN, 474BN See NS Package Number J24A or N24A

Plastic Leaded Chip Carrier (PLCC)



Top View

Order Number DM74S474V, 474AV, 474BV See NS Package Number V28A

Ordering Information

Commercial Temp Range (0°C to +70°C)

Parameter/Order Number	Max Access Time (ns)
DM74S474AJ	45
DM74S474BJ	35
DM74S474J	65
DM74S474AN	45
DM74S474BN	35
DM74S474N	65
DM74S474AV	45
DM74S474BV	35
DM74S474V	65

Military Temp Range (-55°C to + 125°C)

Parameter/Order Number	Max Access Time (ns)
DM54S474AJ	60
DM54S474BJ	50
DM54S474J	75

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

 Supply Voltage (Note 2)
 -0.5V to +7.0V

 Input Voltage (Note 2)
 -1.2V to +5.5V

 Output Voltage (Note 2)
 -0.5V to +5.5V

 Storage Temperature
 -65°C to +150°C

 Lead Temp. (Soldering, 10 seconds)
 300°C

ESD to be determined

Note 1: Absolute maximum ratings are those values beyond which the device may be permanently damaged. They do not mean that the device may be operated at these values.

Note 2: These limits do not apply during programming. For the programming ratings, refer to the programming instructions.

Operating Conditions											
	Min	Max	Units								
Supply Voltage (V _{CC})											
Military	4.50	5.50	V								
Commercial	4.75	5.25	٧								
Ambient Temperature (TA)											
Military	55	+ 125	°C								
Commercial	0	+ 70	°C								
Logical "0" Input Voltage	0	8.0	٧								
Logical "1" Input Voltage	2.0	5.5	٧								

DC Electrical Characteristics (Note 1)

Symbol	Parameter	Conditions		M54S4	74	[Units		
Syllibol	rarameter	Conditions	Min	Тур	Max	Min	Тур	Max	Units
կլ	Input Load Current	$V_{CC} = Max, V_{IN} = 0.45V$		-80	-250		-80	-250	μΑ
I _{IH}	Input Leakage Current	$V_{CC} = Max, V_{IN} = 2.7V$			25			25	μΑ
		$V_{CC} = Max, V_{IN} = 5.5V$			1.0			1.0	mA
V _{OL}	Low Level Output Voltage	V _{CC} = Min, I _{OL} = 16 mA		0.35	0.50		0.35	0.45	٧
VIL	Low Level Input Voltage				0.80			0.80	>
V _{IH}	High Level Input Voltage		2.0			2.0			٧
V _C	Input Clamp Voltage	$V_{CC} = Min, I_{IN} = -18 \text{ mA}$		-0.8	-1.2		-0.8	-1.2	٧
C _I	Input Capacitance	V _{CC} = 5.0V, V _{IN} = 2.0V T _A = 25°C, 1 MHz		4.0			4.0		pF
CO	Output Capacitance	$V_{CC} = 5.0V$, $V_{O} = 2.0V$ $T_{A} = 25^{\circ}C$, 1 MHz, Outputs off		6.0			6.0	·	pF
lcc	Power Supply Current	V _{CC} = Max, Inputs Grounded All Outputs Open		115	170		115	170	mA
los	Short Circuit Output Current	V _O = 0V, V _{CC} = Max (Note 2)	-20		-70	-20		-70	mA
loz	Output Leakage	$V_{CC} = Max, V_{O} = 0.45V \text{ to } 2.4V$			+50			+ 50	μА
	(TRI-STATE)	Chip Disabled			-50			-50	μА
V _{OH}	Output Voltage High	I _{OH} = -2.0 mA	2.4	3.2					V
		$I_{OH} = -6.5 \text{ mA}$				2.4	3.2		V

Note 1: These limits apply over the entire operating range unless stated otherwise. All typical values are for $V_{CC}=5.0V$ and $T_A=25^{\circ}C$.

Note 2: During I_{OS} measurement, only one output at a time should be grounded. Permanent damage may otherwise result.

AC Electrical Characteristics with Standard Load and Operating Conditions

COMMERCIAL TEMP RANGE (0°C to +70°C)

Symbol	JEDEC	Darameter	DM74S474		DM74S474A			DM74S474B				
	Symbol		Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Units
TAA	TAVQV	Address Access Time		40	65		25	45		25	35	ns
TEA	TEVQV	Enable Access Time		20	35		15	25		15	25	ns
TER	TEXQX	Enable Recovery Time		20	35		15	25		15	25	ns
TZX	TEVQX	Output Enable Time		20	35		15	25		15	25	ns
TXZ	TEXQZ	Output Disable Time		20	35		15	25		15	25	ns

MILITARY TEMP RANGE (-55°C to +125°C)

Symbol	JEDEC	Daramatar	DM54S474			DM54S474A			DM54S474B			T
	Symbol		Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Units
TAA	TAVQV	Address Access Time		40	70		25	60		25	50	ns
TEA	TEVQV	Enable Access Time		20	40		15	35		15	35	ns
TER	TEXQX	Enable Recovery Time		20	40		15	35		15	35	ns
TZX	TEVQX	Output Enable Time		20	40		15	35		15	35	ns
TXZ	TEXQZ	Output Disable Time		20	40		15	35		15	35	ns

Functional Description

TESTABILITY

The Schottky PROM die includes extra rows and columns of fusable links for testing the programmability of each chip. These test fuses are placed at the worst-case chip locations to provide the highest possible confidence in the programming tests in the final product. A ROM pattern is also permanently fixed in the additional circuitry and coded to provide a parity check of input address levels. These and other test circuits are used to test for correct operation of the row and column-select circuits and functionality of input and enable gates. All test circuits are available at both wafer and assembled device levels to allow 100% functional and parametric testing at every stage of the test flow.

RELIABILITY

As with all National products, the Ti-W PROMs are subjected to an on-going reliability evaluation by the Reliability Assurance Department. These evaluations employ accelerated life tests, including dynamic high-temperature operating life, temperature-humidity life, temperature cycling, and thermal shock. To date, nearly 7.4 million Schottky Ti-W PROM device hours have been logged, with samples in Epoxy B molded DIP (N-package), PLCC (V-package) and CERDIP (J-package). Device performance in all package configurations is excellent.

TITANIUM-TUNGSTEN FUSES

National's Programmable Read-Only Memories (PROMs) feature titanium-tungsten (Ti-W) fuse links designed to program efficiently with only 10.5V applied. The high performance and reliability of these PROMs are the result of fabrication by a Schottky bipolar process, of which the titanium-tungsten metallization is an integral part, and the use of an on-chip programming circuit.

A major advantage of the titanium-tungsten fuse technology is the low programming voltage of the fuse links. At 10.5V, this virtually eliminates the need for guard-ring devices and wide spacings required for other fuse technologies. Care is taken, however, to minimize voltage drops across the die and to reduce parasitics. The device is designed to ensure that worst-case fuse operating current is low enough for reliable long-term operation. The Darlington programming circuit is liberally designed to insure adequate power density for blowing the fuse links. The complete circuit design is optimized to provide high performance over the entire operating ranges of V_{CC} and temperature.